

## Reference Specification

200°C Operation Leaded MLCC for Automotive (Powertrain/Safety)  
RHS Series

Product specifications in this catalog are as of Feb. 2024, and are subject to change or obsolescence without notice.  
Please consult the approval sheet before ordering. Please read rating and Cautions first.

<Reference> Please kindly use our website.

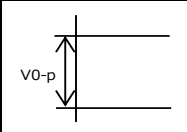
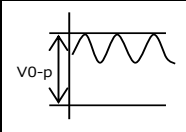
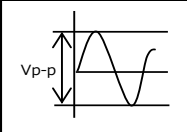
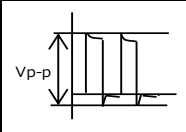
Please refer to the product information page for more information on ceramic capacitors. → [Ceramic capacitor product information](#)

Various data can be obtained directly from the product search. → [Product search \(SMD\)](#) / [Product search \(Lead Type\)](#)

**⚠ CAUTION****1. OPERATING VOLTAGE**

1. Do not apply a voltage to the capacitor that exceeds the rated voltage as called out in the specifications.
  - 1-1. Applied voltage between the terminals of a capacitor shall be less than or equal to the rated voltage.
    - (1) When AC voltage is superimposed on DC voltage, the zero-to-peak voltage shall not exceed the rated DC voltage. When AC voltage or pulse voltage is applied, the peak-to-peak voltage shall not exceed the rated DC voltage.
    - (2) Abnormal voltages (surge voltage, static electricity, pulse voltage, etc.) shall not exceed the rated DC voltage.

Typical Voltage Applied to the DC Capacitor

DC Voltage	DC+AC Voltage	AC Voltage	Pulse Voltage
			

(E: Maximum possible applied voltage.)

**1-2. Influence of over voltage**

Over voltage that is applied to the capacitor may result in an electrical short circuit caused by the breakdown of the internal dielectric layers. The time duration until breakdown depends on the applied voltage and the ambient temperature.

2. Use a safety standard certified capacitor in a power supply input circuit (AC filter), as it is also necessary to consider the withstand voltage and impulse withstand voltage defined for each device.

**2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT**

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

When the capacitor is used in a high-frequency current, pulse current or the like, it may have the self-generated heat due to dielectric-loss. In case of Class 2 capacitors (Temp.Char. : X7R,X7S,X8L, etc.), applied voltage should be the load such as self-generated heat is within 20 °C on the condition of atmosphere temperature 25 °C. Please contact us if self-generated heat is occurred with Class 1 capacitors (Temp.Char. : C0G,U2J,X8G, etc.). When measuring, use a thermocouple of small thermal capacity-K of  $\Phi 0.1\text{mm}$  and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability.

**3. FAIL-SAFE**

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

**4. OPERATING AND STORAGE ENVIRONMENT**

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed 5 to 40 °C and 20 to 70%. Use capacitors within 6 months.

Use capacitors within 6 months after delivered. Check the solderability after 6 months or more.

**⚠ CAUTION****5. VIBRATION AND IMPACT**

Do not expose a capacitor or its leads to excessive shock or vibration during use.

Excessive shock or vibration may cause to fatigue destruction of lead wires mounted on the circuit board.

If necessary, take measures to hold a capacitor on the circuit boards by adhesive, molding resin or coating and other.

Please confirm there is no influence of holding measures on the product with an intended equipment.

**6. SOLDERING**

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

Please verify that the soldering process does not affect the quality of capacitors.

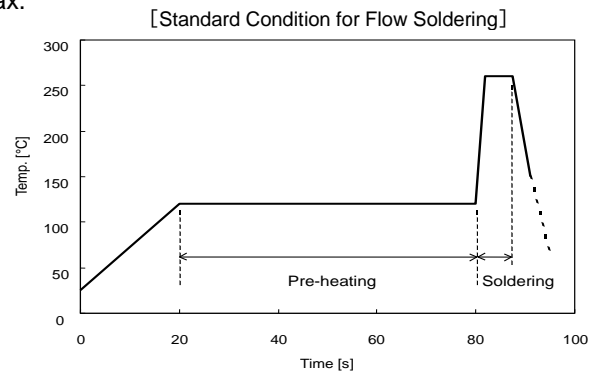
**6-1. Flow Soldering**

Soldering temperature : 260 °C max.

Soldering time : 7.5 s max.

Preheating temperature : 120 °C max.

Preheating time : 60 s max.

**6-2. Reflow Soldering**

Do not apply reflow soldering.

**6-3. Soldering Iron**

Temperature of iron-tip : 350 °C max.

Soldering iron wattage : 60 W max.

Soldering time : 3.5 s max.

**7. BONDING AND RESIN MOLDING, RESIN COAT**

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of a bonded or molded product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive or molding resin may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

**8. TREATMENT AFTER BONDING AND RESIN MOLDING, RESIN COAT**

When the outer coating is hot (over 100 °C) after soldering, it becomes soft and fragile.

So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

**⚠ CAUTION**

**9. LIMITATION OF APPLICATIONS**

The products listed in the specification (hereinafter the product(s) is called as the "Product(s)") are designed and manufactured for applications specified in the specification. (hereinafter called as the "Specific Application")

We shall not warrant anything in connection with the Products including fitness, performance, adequateness, safety, or quality, in the case of applications listed in from (1) to (11) written at the end of this precautions, which may generally require high performance, function, quality, management of production or safety.

Therefore, the Product shall be applied in compliance with the specific application.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT (i) THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS NOT SPECIFIED AS THE SPECIFIC APPLICATION FOR THE PRODUCT, AND/OR (ii) THE PRODUCT IS APPLIED FOR ANY FOLLOWING APPLICATION PURPOSES FROM (1) TO (11) (EXCEPT THAT SUCH APPLICATION PURPOSE IS UNAMBIGUOUSLY SPECIFIED AS SPECIFIC APPLICATION FOR THE PRODUCT IN OUR CATALOG SPECIFICATION FORMS, DATASHEETS, OR OTHER DOCUMENTS OFFICIALLY ISSUED BY US\*)

1. Aircraft equipment
2. Aerospace equipment
3. Undersea equipment
4. Power plant control equipment
5. Medical equipment
6. Transportation equipment
7. Traffic control equipment
8. Disaster prevention/security equipment
9. Industrial data-processing equipment
10. Combustion/explosion control equipment
11. Equipment with complexity and/or required reliability equivalent to the applications listed in the above.

For exploring information of the Products which will be compatible with the particular purpose other than those specified in the specification, please contact our sales offices, distribution agents, or trading companies with which you make a deal, or via our web contact form.

Contact form: <https://www.murata.com/contactform>

\*We may design and manufacture particular Products for applications listed in (1) to (11). Provided that, in such case we shall unambiguously specify such Specific Application in the specification without any exception.

Therefore, any other documents and/or performances, whether exist or non-exist, shall not be deemed as the evidence to imply that we accept the applications listed in (1) to (11).

**⚠ CAUTION  
NOTICE**

**1. CLEANING (ULTRASONIC CLEANING)**

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity : Output of 20 watts per liter or less.

Rinsing time : 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

**2. SOLDERING AND MOUNTING**

Insertion of the Lead Wire

- When soldering, insert the lead wire into the PCB without mechanically stressing the lead wire.
- Insert the lead wire into the PCB with a distance appropriate to the lead space.

**3. CAPACITANCE CHANGE OF CAPACITORS**

- Class 2 capacitors (Temp.Char. : X7R,X7S,X8L etc.)

Class 2 capacitors an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit.

Please contact us if you need a detail information.

**⚠ NOTE**

1. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
2. You are requested not to use our product deviating from this product specification.

## 1. Application

This product specification is applied to Leaded MLCC RHS series.

### 1. Specific applications:

- Automotive powertrain/safety equipment: Products that can be used for automotive equipment related to running, turning, stopping, safety devices, etc., or equipment whose structure, equipment, and performance are legally required to meet technical standards for safety assurance or environmental protection.
- Automotive infotainment/comfort equipment: Products that can be used for automotive equipment such as car navigation systems and car audio systems that do not directly relate to human life and whose structure, equipment, and performance are not specifically required by law to meet technical standards for safety assurance or environmental protection.
- Medial Equipment [GHTF A/B/C] except for Implant Equipment: Products suitable for use in medical devices designated under the GHTF international classifications as Class A or Class B (the functions of which are not directly involved in protection of human life or property) or in medical devices other than implants designated under the GHTF international classifications as Class C (the malfunctioning of which is considered to pose a comparatively high risk to the human body).

2.Unsuitable Application: Applications listed in "Limitation of applications" in this product specification.

## 2. Rating

- Applied maximum temperature up to 200°C

Note : Maximum accumulative time to 200°C is within 2000 hours.

- Part Number Configuration

ex.)

RHS	7G	2A	332	J	1	A2	H01	B
Series	Temperature Characteristics	Rated Voltage	Capacitance	Capacitance Tolerance	Dimension (LxW)	Lead Style	Individual Specification	Package

- Series

Code	Content
RHS	Epoxy coated, 200°C max.

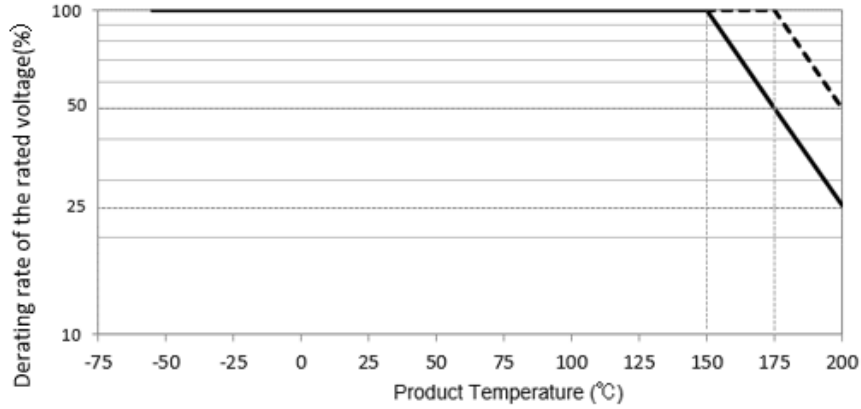
- Temperature Characteristics

Code	Temp. Char.	Temp. Range	Temp.coef.	Standard Temp.	Operating Temp. Range
7G	CCG (Murata code)	-55~25°C	0+30/-72ppm/°C	25°C	-55~200°C
		25~125°C	0+/-30ppm/°C		
		125~200°C	0+72/-30ppm/°C		

• Rated Voltage

Code	Rated voltage
2A	DC100V

When the product temperature exceeds 150°C, please use this product within the voltage and temperature derated conditions in the figure below.



-----	Temp. Char. : CCG, Rated Voltage : 100V, Capacitance : 100pF-1000pF
—————	Temp. Char. : CCG, Rated Voltage : 100V, Capacitance : 1200pF-3300pF

• Capacitance

The first two digits denote significant figures ; the last digit denotes the multiplier of 10 in pF.

ex.) In case of 332 .

$$33 \times 10^2 = 3300 \text{ pF}$$

• Capacitance Tolerance

Code	Capacitance Tolerance
J	+/-5%

• Dimension (LxW)

Please refer to [ Part number list ].

• Lead Style

\*Lead wire is "solder coated CP wire".

Code	Lead Style	Lead spacing (mm)
A2	Straight type	2.5+/-0.8
DG	Straight taping type	2.5+0.4/-0.2
K1	Inside crimp type	5.0+/-0.8
M2	Inside crimp taping type	5.0+0.6/-0.2

• Individual Specification

Murata's control code.

Please refer to [ Part number list ].

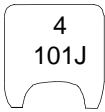
• Package

Code	Package
A	Taping type of Ammo
B	Bulk type

## 3. Marking

Temp. char. : Letter code : 4 (CCG char.)  
Capacitance : 3 digit numbers  
Capacitance tolerance : Code

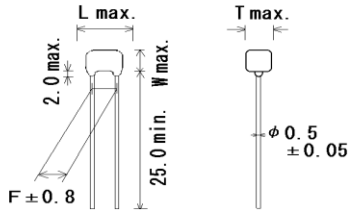
(Ex.)

Rated voltage	DC100V
Dimension code	
0,1	

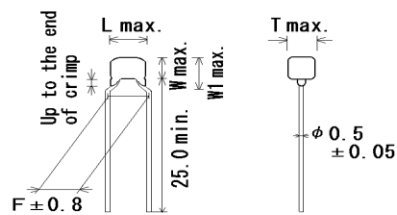


4. Part number list

- Straight Long  
(Lead Style:A2)



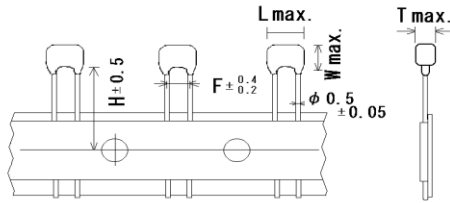
- Inside Crimp  
(Lead Style :K\*)



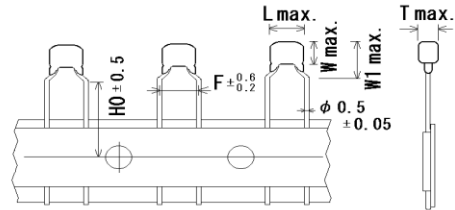
Unit : mm

Customer Part Number	Murata Part Number	T.C.	DC Rated Volt. (V)	Cap.	Cap. Tol.	Dimension (mm)					Dimension (LxW) Lead Style	Pack qty. (pcs)
						L	W	W1	F	T		
	RHS7G2A101J0A2H01B	CCG	100	100pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A121J0A2H01B	CCG	100	120pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A151J0A2H01B	CCG	100	150pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A181J0A2H01B	CCG	100	180pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A221J0A2H01B	CCG	100	220pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A271J0A2H01B	CCG	100	270pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A331J0A2H01B	CCG	100	330pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A391J0A2H01B	CCG	100	390pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A471J0A2H01B	CCG	100	470pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A561J0A2H01B	CCG	100	560pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A681J0A2H01B	CCG	100	680pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A821J0A2H01B	CCG	100	820pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A102J0A2H01B	CCG	100	1000pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A122J0A2H01B	CCG	100	1200pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A152J0A2H01B	CCG	100	1500pF	±5%	3.9	3.5	-	2.5	2.6	0A2	500
	RHS7G2A182J1A2H01B	CCG	100	1800pF	±5%	4.2	3.5	-	2.5	2.8	1A2	500
	RHS7G2A222J1A2H01B	CCG	100	2200pF	±5%	4.2	3.5	-	2.5	2.8	1A2	500
	RHS7G2A272J1A2H01B	CCG	100	2700pF	±5%	4.2	3.5	-	2.5	2.8	1A2	500
	RHS7G2A332J1A2H01B	CCG	100	3300pF	±5%	4.2	3.5	-	2.5	2.8	1A2	500
	RHS7G2A101J0K1H01B	CCG	100	100pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A121J0K1H01B	CCG	100	120pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A151J0K1H01B	CCG	100	150pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A181J0K1H01B	CCG	100	180pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A221J0K1H01B	CCG	100	220pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A271J0K1H01B	CCG	100	270pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A331J0K1H01B	CCG	100	330pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A391J0K1H01B	CCG	100	390pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A471J0K1H01B	CCG	100	470pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A561J0K1H01B	CCG	100	560pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A681J0K1H01B	CCG	100	680pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A821J0K1H01B	CCG	100	820pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A102J0K1H01B	CCG	100	1000pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A122J0K1H01B	CCG	100	1200pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A152J0K1H01B	CCG	100	1500pF	±5%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHS7G2A182J1K1H01B	CCG	100	1800pF	±5%	4.2	3.5	5.0	5.0	2.8	1K1	500
	RHS7G2A222J1K1H01B	CCG	100	2200pF	±5%	4.2	3.5	5.0	5.0	2.8	1K1	500
	RHS7G2A272J1K1H01B	CCG	100	2700pF	±5%	4.2	3.5	5.0	5.0	2.8	1K1	500
	RHS7G2A332J1K1H01B	CCG	100	3300pF	±5%	4.2	3.5	5.0	5.0	2.8	1K1	500

- Straight Taping  
(Lead Style :DG)



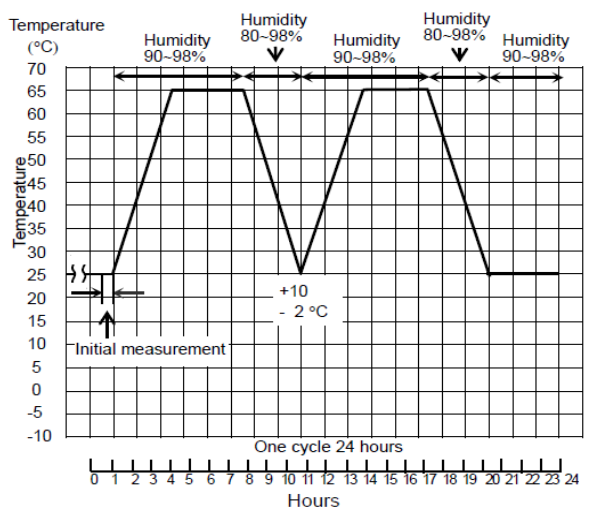
- Inside Crimp Taping  
(Lead Style :M2)



Unit : mm

Customer Part Number	Murata Part Number	T.C.	DC Rated Volt. (V)	Cap.	Cap. Tol.	Dimension (mm)						Dimension (LxW) Lead Style	Pack qty. (pcs)
						L	W	W1	F	T	H/H0		
	RHS7G2A101J0DGH01A	CCG	100	100pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A121J0DGH01A	CCG	100	120pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A151J0DGH01A	CCG	100	150pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A181J0DGH01A	CCG	100	180pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A221J0DGH01A	CCG	100	220pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A271J0DGH01A	CCG	100	270pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A331J0DGH01A	CCG	100	330pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A391J0DGH01A	CCG	100	390pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A471J0DGH01A	CCG	100	470pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A561J0DGH01A	CCG	100	560pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A681J0DGH01A	CCG	100	680pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A821J0DGH01A	CCG	100	820pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A102J0DGH01A	CCG	100	1000pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A122J0DGH01A	CCG	100	1200pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A152J0DGH01A	CCG	100	1500pF	±5%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHS7G2A182J1DGH01A	CCG	100	1800pF	±5%	4.2	3.5	-	2.5	2.8	20.0	1DG	2000
	RHS7G2A222J1DGH01A	CCG	100	2200pF	±5%	4.2	3.5	-	2.5	2.8	20.0	1DG	2000
	RHS7G2A272J1DGH01A	CCG	100	2700pF	±5%	4.2	3.5	-	2.5	2.8	20.0	1DG	2000
	RHS7G2A332J1DGH01A	CCG	100	3300pF	±5%	4.2	3.5	-	2.5	2.8	20.0	1DG	2000
	RHS7G2A101J0M2H01A	CCG	100	100pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A121J0M2H01A	CCG	100	120pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A151J0M2H01A	CCG	100	150pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A181J0M2H01A	CCG	100	180pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A221J0M2H01A	CCG	100	220pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A271J0M2H01A	CCG	100	270pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A331J0M2H01A	CCG	100	330pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A391J0M2H01A	CCG	100	390pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A471J0M2H01A	CCG	100	470pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A561J0M2H01A	CCG	100	560pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A681J0M2H01A	CCG	100	680pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A821J0M2H01A	CCG	100	820pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A102J0M2H01A	CCG	100	1000pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A122J0M2H01A	CCG	100	1200pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A152J0M2H01A	CCG	100	1500pF	±5%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHS7G2A182J1M2H01A	CCG	100	1800pF	±5%	4.2	3.5	5.0	5.0	2.8	20.0	1M2	2000
	RHS7G2A222J1M2H01A	CCG	100	2200pF	±5%	4.2	3.5	5.0	5.0	2.8	20.0	1M2	2000
	RHS7G2A272J1M2H01A	CCG	100	2700pF	±5%	4.2	3.5	5.0	5.0	2.8	20.0	1M2	2000
	RHS7G2A332J1M2H01A	CCG	100	3300pF	±5%	4.2	3.5	5.0	5.0	2.8	20.0	1M2	2000

Reference only

5. Specification																			
No.	Test Item		Specification	Test Method (Compliant Standard:AEC-Q200)															
1	Pre-and Post-Stress Electrical Test			-															
2	High Temperature Exposure (Storage)	Appearance	No defects or abnormalities except color change of outer coating.	Sit the capacitor for 1000±12 hours at 200±5°C. Let sit for 24±2 hours at *room condition, then measure.															
		Capacitance Change	Within ±3% or ±0.3pF (Whichever is larger)																
		Q	Q ≥ 350																
		I.R.	1,000MΩ min.																
3	Temperature Cycling	Appearance	No defects or abnormalities except color change of outer coating	Perform the 1000 cycles according to the four heat treatments listed in the following table. Let sit for 24±2 hours at *room condition, then measure.															
		Capacitance Change	Within ±5% or ±0.5pF (Whichever is larger)																
		Q	Q ≥ 350																
		I.R.	1,000MΩ min.																
<table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Step</th> <th>1</th> <th>2</th> <th>3</th> <th>4</th> </tr> </thead> <tbody> <tr> <td>Temp. (°C)</td> <td>-55+0/-3</td> <td>Room Temp.</td> <td>200+5/-0</td> <td>Room Temp.</td> </tr> <tr> <td>Time (min.)</td> <td>15±3</td> <td>1</td> <td>15±3</td> <td>1</td> </tr> </tbody> </table>					Step	1	2	3	4	Temp. (°C)	-55+0/-3	Room Temp.	200+5/-0	Room Temp.	Time (min.)	15±3	1	15±3	1
Step	1	2	3	4															
Temp. (°C)	-55+0/-3	Room Temp.	200+5/-0	Room Temp.															
Time (min.)	15±3	1	15±3	1															
4	Moisture Resistance	Appearance	No defects or abnormalities.	Apply the 24 hours heat (25 to 65°C) and humidity (80 to 98%) treatment shown below, 10 consecutive times. Let sit for 24±2 hours at *room condition, then measure.															
		Capacitance Change	Within ±5% or ± 0.5pF (Whichever is larger)																
		Q	Q ≥ 200																
		I.R.	500MΩ min.																
 <p>The graph shows a temperature profile over 24 hours. The y-axis is Temperature (°C) from -10 to 70. The x-axis is Hours from 0 to 24. The profile starts at 25°C, rises to 65°C at 4 hours, stays at 65°C until 8 hours, drops to 25°C at 10 hours, rises to 65°C at 12 hours, stays at 65°C until 16 hours, drops to 25°C at 18 hours, and stays at 25°C until 24 hours. Humidity levels are indicated: 90-98% for the first 8 hours, 80-98% for the next 4 hours, 90-98% for the next 4 hours, 80-98% for the next 4 hours, and 90-98% for the final 4 hours. An initial measurement is taken at 2 hours. A temperature fluctuation of +10°C and -2°C is noted during the 65°C plateau.</p>																			
5	Biased Humidity	Appearance	No defects or abnormalities.	Apply the rated voltage and DC1.3+0.2/-0V (add 100kΩ resistor) at 85±3°C and 80 to 85% humidity for 1000±12 hours. Remove and let sit for 24±2 hours at *room condition, then measure. The charge/discharge current is less than 50mA.															
		Capacitance Change	Within ±5% or ± 0.5pF (Whichever is larger)																
		Q	Q ≥ 200																
		I.R.	500MΩ min.																
6	Operational Life	Appearance	No defects or abnormalities except color change of outer coating.	Apply voltage in Table for 1,000±12h at 200±5°C. Let sit for 24±2 hours at *room condition, then measure. The charge/discharge current is less than 50mA.															
		Capacitance Change	Within ±3% or ±0.3pF (Whichever is larger)																
		Q	Q ≥ 350																
		I.R.	1,000MΩ min.																
<table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Capacitance</th> <th>Test Voltage</th> </tr> </thead> <tbody> <tr> <td>100pF-1000pF</td> <td>50% of the rated voltage</td> </tr> <tr> <td>1200pF-3300pF</td> <td>25% of the rated voltage</td> </tr> </tbody> </table>					Capacitance	Test Voltage	100pF-1000pF	50% of the rated voltage	1200pF-3300pF	25% of the rated voltage									
Capacitance	Test Voltage																		
100pF-1000pF	50% of the rated voltage																		
1200pF-3300pF	25% of the rated voltage																		
7	External Visual		No defects or abnormalities.	Visual inspection.															
8	Physical Dimension		Within the specified dimensions.	Using calipers and micrometers.															
9	Marking		To be easily legible.	Visual inspection.															
10	Resistance to Solvents	Appearance	No defects or abnormalities.	Per MIL-STD-202 Method 215 Solvent 1 : 1 part (by volume) of isopropyl alcohol 3 parts (by volume) of mineral spirits Solvent 2 : Terpene defluxer Solvent 3 : 42 parts (by volume) of water 1part (by volume) of propylene glycol monomethyl ether 1 part (by volume) of monoethanolamine															
		Capacitance	Within the specified tolerance.																
		Q	Q ≥ 1,000																
		I.R.	10,000MΩ min.																
* "room condition" Temperature : 15 to 35°C, Relative humidity : 45 to 75%, Atmosphere pressure : 86 to 106kPa																			

Reference only

No.	Test Item	Specification	Test Method (Compliant Standard:AEC-Q200)									
11	Mechanical Shock	Appearance	No defects or abnormalities.									
		Capacitance	Within the specified tolerance.									
		Q	$Q \geq 1,000$									
12	Vibration	Appearance	No defects or abnormalities.									
		Capacitance	Within the specified tolerance.									
		Q	$Q \geq 1,000$									
13-1	Resistance to Soldering Heat (Non-Preheat)	Appearance	No defects or abnormalities.									
		Capacitance Change	Within $\pm 2.5\%$ or $\pm 0.25\text{pF}$ (Whichever is larger)									
		Dielectric Strength (Between terminals)	No defects.									
13-2	Resistance to Soldering Heat (On-Preheat)	Appearance	No defects or abnormalities.									
		Capacitance Change	Within $\pm 2.5\%$ or $\pm 0.25\text{pF}$ (Whichever is larger)									
		Dielectric Strength (Between terminals)	No defects.									
13-3	Resistance to Soldering Heat (soldering iron method)	Appearance	No defects or abnormalities.									
		Capacitance Change	Within $\pm 2.5\%$ or $\pm 0.25\text{pF}$ (Whichever is larger)									
		Dielectric Strength (Between terminals)	No defects.									
14	Thermal Shock	Appearance	No defects or abnormalities.									
		Capacitance Change	Within $\pm 5\%$ or $\pm 0.5\text{pF}$ (Whichever is larger)									
		Q	$Q \geq 350$									
		I.R.	1,000M $\Omega$ min.									
15	ESD	Appearance	No defects or abnormalities.									
		Capacitance	Within the specified tolerance.									
		Q	$Q \geq 1,000$									
		I.R.	10,000M $\Omega$ min.									
16	Solderability	Lead wire should be soldered with uniform coating on the axial direction over 95% of the circumferential direction.	<p>The terminal of capacitor is dipped into a solution of rosin ethanol (25% rosin in weight proportion).                      Immerse in solder solution for <math>2 \pm 0.5</math> seconds.                      In both cases the depth of dipping is up to about 1.5 to 2mm from the terminal body.                      Temp. of solder : <math>245 \pm 5^\circ\text{C}</math> (Sn-3.0Ag-0.5Cu)</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Step</th> <th>1</th> <th>2</th> </tr> </thead> <tbody> <tr> <td>Temp. (<math>^\circ\text{C}</math>)</td> <td><math>-55 \pm 0/-3</math></td> <td><math>200 \pm 5/-0</math></td> </tr> <tr> <td>Time (min.)</td> <td><math>15 \pm 3</math></td> <td><math>15 \pm 3</math></td> </tr> </tbody> </table>	Step	1	2	Temp. ( $^\circ\text{C}$ )	$-55 \pm 0/-3$	$200 \pm 5/-0$	Time (min.)	$15 \pm 3$	$15 \pm 3$
Step	1	2										
Temp. ( $^\circ\text{C}$ )	$-55 \pm 0/-3$	$200 \pm 5/-0$										
Time (min.)	$15 \pm 3$	$15 \pm 3$										
* "room condition" Temperature : 15 to 35°C, Relative humidity : 45 to 75%, Atmosphere pressure : 86 to 106kPa												

Reference only

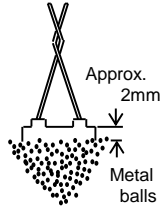
No.	Test Item	Specification	Test Method (Compliant Standard:AEC-Q200)	
17	Electrical Characterization	Appearance	No defects or abnormalities.	
		Capacitance	Within the specified tolerance.	
		Q	$Q \geq 1,000$	
	Insulation Resistance (I.R.)	Room Temperature	10,000MΩ min.	The insulation resistance should be measured at 25±3 °C with a DC voltage not exceeding the rated voltage at normal temperature and humidity and within 2 min. of charging. (Charge/Discharge current ≤ 50mA.)
		High Temperature	20MΩ min.	The insulation resistance should be measured at 200±5°C with a DC voltage not exceeding voltage in Table and within 2 min. of charging. (Charge/Discharge current ≤ 50mA.)
Dielectric Strength	Between Terminals	No defects or abnormalities.	The capacitor should not be damaged when voltage in Table is applied between the terminations for 1 to 5 seconds. (Charge/Discharge current ≤ 50mA.)	
	Terminal To External Resin	No defects or abnormalities.	The capacitor is placed in a container with metal balls of 1mm diameter so that each terminal, short-circuit, is kept approximately 2mm from the balls as shown in the figure, and voltage in table is impressed for 1 to 5 seconds between capacitor terminals and metal balls. (Charge/Discharge current ≤ 50mA.)	
18	Terminal Strength	Tensile Strength	Termination not to be broken or loosened.	
		Bending Strength	Termination not to be broken or loosened.	
19	Capacitance Temperature Characteristics	Within the specified Tolerance.	0+30/-72ppm/°C (-55 to 25°C) 0±30ppm/°C (25 to 125°C) 0+72/-30ppm/°C (125 to 200°C)	
			The capacitance change should be measured after 5min. at each specified temperature step.	

Nominal Cap.	Frequency	Voltage
$C \leq 1000\text{pF}$	1±0.1MHz	AC0.5 to 5V(r.m.s.)
$C > 1000\text{pF}$	1±0.1kHz	AC1±0.2V(r.m.s.)

Capacitance	Test Voltage
100pF-1000pF	50% of the rated voltage
1200pF-3300pF	25% of the rated voltage

Rated Voltage	Test Voltage
DC100V	300% of the rated voltage

Rated Voltage	Test Voltage
DC100V	250% of the rated voltage



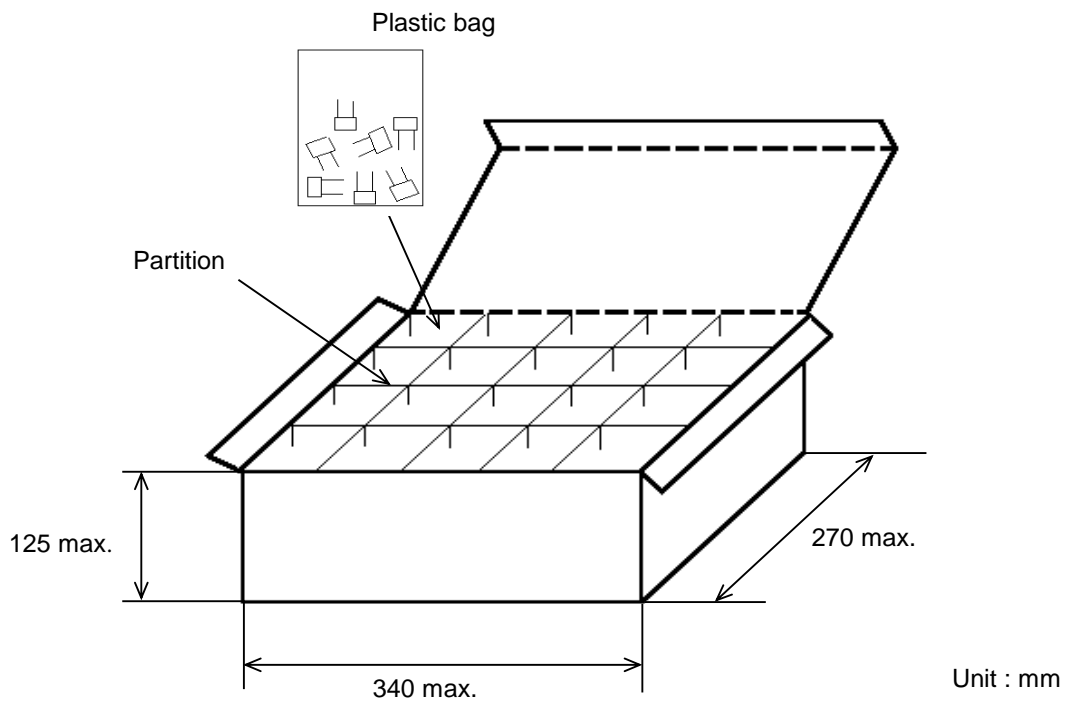
Step	Temperature(°C)
1	25±2
2	-55±3
3	25±2
4	200±5
5	25±2

\* "room condition" Temperature : 15 to 35°C, Relative humidity : 45 to 75%, Atmosphere pressure : 86 to 106kPa

6. Packing specification

- Bulk type (Packing style code : B)

The size of packing case and packing way



$$\text{The number of packing} = {}^*1 \text{ Packing quantity} \times {}^*2 n$$

\*1 : Please refer to [Part number list].

\*2 : Standard n = 20 (bag)

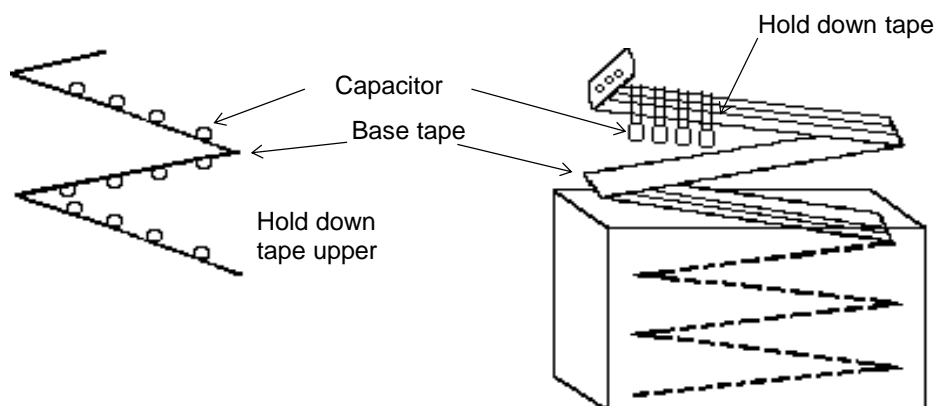
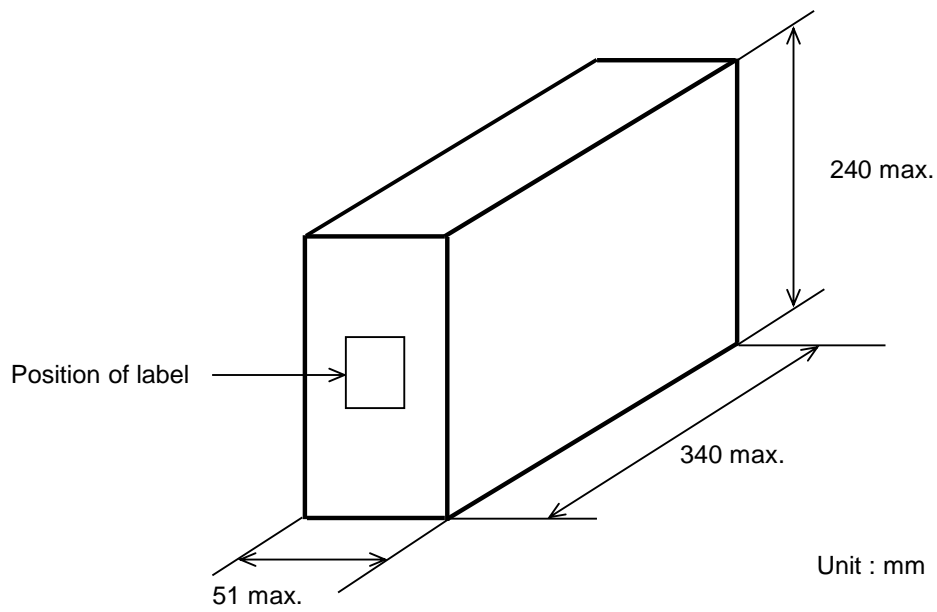
Note)

The outer package and the number of outer packing be changed by the order getting amount.

• Ammo pack taping type (Packing style code : A)

A crease is made every 25 pitches, and the tape with capacitors is packed zigzag into a case. When body of the capacitor is piled on other body under it.

The size of packing case and packing way

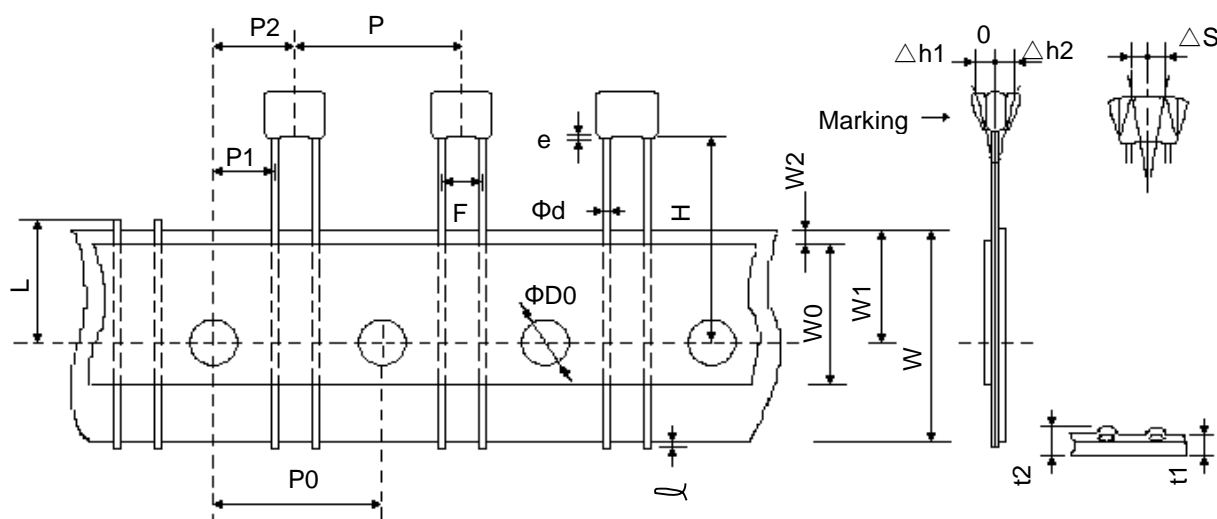


## 7. Taping specification

## 7-1. Dimension of capacitors on tape

Straight taping type &lt; Lead Style : DG &gt;

Pitch of component 12.7mm / Lead spacing 2.5mm



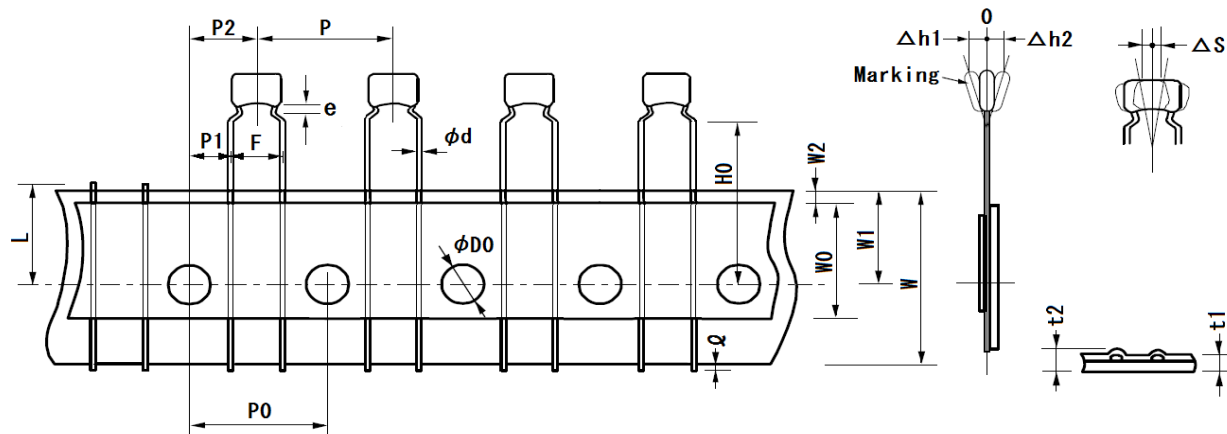
Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	12.7+/-1.0	
Pitch of sprocket hole	P0	12.7+/-0.2	
Lead spacing	F	2.5+0.4/-0.2	
Length from hole center to component center	P2	6.35+/-1.3	Deviation of progress direction
Length from hole center to lead	P1	5.1+/-0.7	
Deviation along tape, left or right defect	ΔS	0+/-2.0	They include deviation by lead bend
Carrier tape width	W	18.0+/-0.5	
Position of sprocket hole	W1	9.0+0/-0.5	Deviation of tape width direction
Lead distance between reference and bottom plane	H	20.0+/-0.5	
Protrusion length	ℓ	0.5 max.	
Diameter of sprocket hole	ΦD0	4.0+/-0.1	
Lead diameter	Φd	0.5+/-0.05	
Total tape thickness	t1	0.6+/-0.3	They include hold down tape thickness
Total thickness of tape and lead wire	t2	1.5 max.	
Deviation across tape	Δh1	1.0 max.	
	Δh2		
Portion to cut in case of defect	L	11.0+0/-1.0	
Hold down tape width	W0	9.5 min.	
Hold down tape position	W2	1.5+/-1.5	
Coating extension on lead	e	2.0 max.	



Inside crimp taping type < Lead Style : M2 >

Pitch of component 12.7mm / Lead spacing 5.0mm

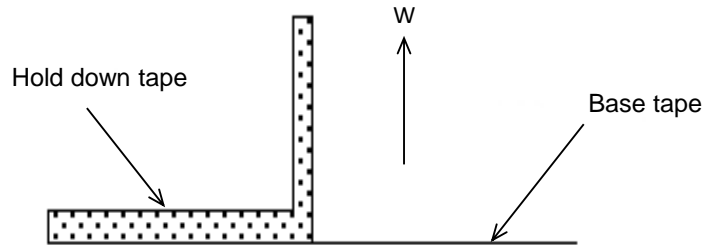


Unit : mm

Item	Code	Dimensions	Remarks
Pitch of component	P	12.7+/-1.0	
Pitch of sprocket hole	P0	12.7+/-0.2	
Lead spacing	F	5.0+0.6/-0.2	
Length from hole center to component center	P2	6.35+/-1.3	Deviation of progress direction
Length from hole center to lead	P1	3.85+/-0.7	
Deviation along tape, left or right defect	ΔS	0+/-2.0	They include deviation by lead bend
Carrier tape width	W	18.0+/-0.5	
Position of sprocket hole	W1	9.0+0/-0.5	Deviation of tape width direction
Lead distance between reference and bottom plane	H0	20.0+/-0.5	
Protrusion length	ℓ	0.5 max.	
Diameter of sprocket hole	ΦD0	4.0+/-0.1	
Lead diameter	Φd	0.5+/-0.05	
Total tape thickness	t1	0.6+/-0.3	They include hold down tape thickness
Total thickness of tape and lead wire	t2	1.5 max.	
Deviation across tape	Δh1	2.0 max. (Dimension code : W)	
	Δh2	1.0 max. (except as above)	
Portion to cut in case of defect	L	11.0+0/-1.0	
Hold down tape width	W0	9.5 min.	
Hold down tape position	W2	1.5+/-1.5	
Coating extension on lead	e	Up to the end of crimp	

7-2. Splicing way of tape

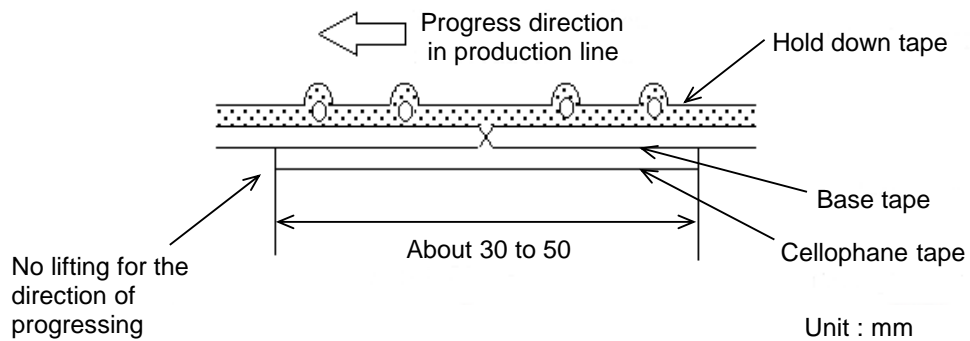
- 1) Adhesive force of tape is over 3N at test condition as below.



2) Splicing of tape

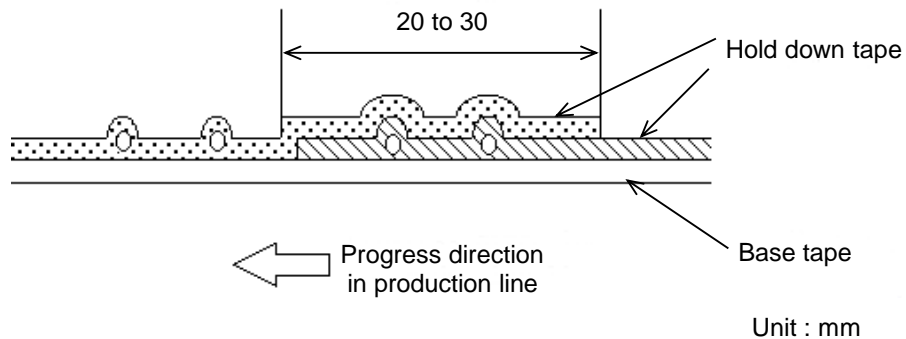
- a) When base tape is spliced

- Base tape shall be spliced by cellophane tape.  
(Total tape thickness shall be less than 1.05mm.)



- b) When hold down tape is spliced

- Hold down tape shall be spliced with overlapping.  
(Total tape thickness shall be less than 1.05mm.)



- c) When both tape are spliced

- Base tape and hold down tape shall be spliced with splicing tape.